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| INFORMATION<br>DISCLOSURE<br>CITATION | Applicant: <b>Shiro MIYAZAKI et al.</b> | D. Rec'd PCT/PTO 15 OCT 2004 |                              |
|                                       | Ser. No.: <b>Unknown</b>                |                              | Filed: <b>Unknown</b>        |
|                                       | Conf. No.: <b>Unknown</b>               |                              | Atty. Ref.: <b>OPS C-658</b> |
|                                       | Group: <b>Unknown</b>                   |                              |                              |

## U.S. PATENT DOCUMENTS

| Examiner<br>Initial* | Document<br>Number | Date      | Name    | Class         | Sub<br>Class | Filing<br>Date |
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|                      | AE                 |           |         |               |              |                |
|                      | AF                 |           |         |               |              |                |
|                      | AG                 |           |         |               |              |                |
|                      | AH                 |           |         |               |              |                |

## FOREIGN PATENT DOCUMENTS

|      | Document<br>Number | Date           | Country | Class | Sub<br>Class                                       | Translation<br>Yes No |
|------|--------------------|----------------|---------|-------|----------------------------------------------------|-----------------------|
| U.D. | AI                 | JP 6-79340     | 03/1994 | Japan | With English abstract and full English translation |                       |
| U.D. | AJ                 | JP 6-266474    | 09/1994 | Japan | With English abstract.                             |                       |
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| U.D. | AP | Miyazaki, Y., et al., "Oscillatory Flow in the Oscillating Heat Pipe", Fukui University of Technology, Fukui, Japan (7 pages)                                                                       |

EXAMINER

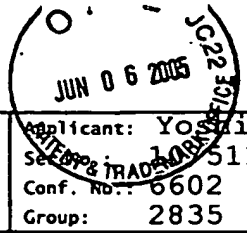
*Leif Dabbe*

DATE CONSIDERED

02/13/06

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| INFORMATION<br>DISCLOSURE<br>CITATION | Applicant: Yoshiro MIYAZAKI et al |
|                                       | Serial No.: 100511 778            |
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|                                       | Atty. Docket No.: OPS Case 658    |
|                                       | Conf. No.: 6602                   |
|                                       | Group: 2835                       |

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|                    | AK       |                             |                             |                               |

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| H. G.                                 | AQ       | "Water Cooling Modules for Notebook PCs" by T. Nakagawa, Vol. 84 No. 11, 2002, 715-718, 51-54, in Japanese, with English translation of the gist of the publication. |
|                                       | AR       |                                                                                                                                                                      |
| EXAMINER SIGNATURE <i>[Signature]</i> |          | DATE CONSIDERED 02/13/06                                                                                                                                             |

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